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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	133
Program Memory Size	1.5MB (1.5M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LFBGA
Supplier Device Package	176-LFBGA (13x13)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631dcdbg-u0

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and table 1.2 gives a comparison of the functions of products in different packages.

Table 1.1 is for products with the greatest number of functions, so numbers of peripheral modules and channels will differ in accord with the package. For details, see Table 1.2, Comparison of Functions for Different Packages in the RX63N/RX631 Group.

Table 1.1 Outline of Specifications (1/6)

Classification	Module/Function	Description
CPU	CPU	- Maximum operating frequency: 100 MHz 32-bit RX CPU - Minimum instruction execution time: One instruction per state (cycle of the system clock) - Address space: 4-Gbyte linear - Register set of the CPU - General purpose: Sixteen 32-bit registers - Control: Nine 32-bit registers - Accumulator: One 64-bit register - Basic instructions: 73 - Floating-point instructions: 8 - DSP instructions: 9 - Addressing modes: 10 - Data arrangement - Instructions: Little endian - Data: Selectable as little endian or big endian - On-chip 32-bit multiplier: 32 x 32 → 64 bits - On-chip divider: 32 / 32 → 32 bits - Barrel shifter: 32 bits - Memory protection unit (MPU)
	FPU	- Single precision (32-bit) floating point - Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	- Capacity: ROMless, 256 Kbytes, 384 Kbytes, 512 Kbytes, 768 Kbytes, 1 Mbyte, 1.5 Mbytes, 2 Mbytes 100 MHz, no-wait access - On-board programming: Four types - Off-board programming (parallel programmer mode) (for products with 100 pins or more)
	RAM	- Capacity: 64 Kbytes, 128 Kbytes, 192 Kbytes, 256 Kbytes 100 MHz, no-wait access
	E2 data flash	Capacity: 32 Kbytes Programming/erasing: 100,000 times
MCU operating modes		Single-chip mode, on-chip ROM enabled expansion mode, and on-chip ROM disabled expansion mode (software switching)
Clock	Clock generation circuit	- Main clock oscillator, subclock oscillator, low-speed/high-speed on-chip oscillator, PLL frequency synthesizer, and IWDG-dedicated on-chip oscillator - Main-clock oscillation stoppage detection - Separate frequency-division and multiplication settings for the system clock (ICLK), peripheral module clock (PCLK), FlashIF clock (FCLK) and external bus clock (BCLK) The CPU and other bus masters run in synchronization with the system clock (ICLK): Up to 100 MHz Peripheral modules run in synchronization with the peripheral module clock (PCLK): Up to 50 MHz Flash IF run in synchronization with the flashIF clock (FCLK): Up to 50 MHz Devices connected to the external bus run in synchronization with the external bus clock (BCLK): Up to 50 MHz
Reset		RES# pin reset, power-on reset, voltage-monitoring reset, independent watchdog timer reset, watchdog timer reset, deep software standby reset, and software reset
Voltage detection circuit		When the voltage on VCC passes the voltage detection level (Vdet), an internal reset or internal interrupt is generated.

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no.

Table 1.3 List of Products (1/8)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX63N (D version)	R5F563NECDLC	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDLC	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDLC	PTLG0177KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDL	PTLG0177KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDLC	PTLG0177KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDL	PTLG0177KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDLC	PTLG0177KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDLC	PTLG0177KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDBG	PLBG0176GA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDBG	PLBG0176GA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDBG	PLBG0176GA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDBG	PLBG0176GA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDBG	PLBG0176GA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDBG	PLBG0176GA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDBG	PLBG0176GA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDBG	PLBG0176GA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFHDFC	PLQP0176KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFDDFC	PLQP0176KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKHDFC	PLQP0176KB-A*1	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKDDFC	PLQP0176KB-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJHDFC	PLQP0176KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJDDFC	PLQP0176KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGHDFC	PLQP0176KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGDDFC	PLQP0176KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYHDFC	PLQP0176KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYDDFC	PLQP0176KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWHDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWDDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWGDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWCDFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDFC	PLQP0176KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDFC	PLQP0176KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDFC	PLQP0176KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDFC	PLQP0176KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDLK	PTLG0145KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDLK	PTLG0145KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDLK	PTLG0145KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C

Table 1.4 Pin Functions (5/6)

Classifications	Pin Name	I/O	Description
Ethernet controller	ET_MDIO	I/O	Inputs or outputs bidirectional signals for exchange of management information between the RX63N Group and the PHY-LSI.
Parallel data capture unit (PDC)	PIXCLK	Input	Parallel data transfer clock
	VSYNC	Input	Vertical synchronization signal
	HSYNC	Input	Horizontal synchronization signal
	PIXD7 to PIXD0	Input	8-bit data
	PCKO	Output	Outputs parallel data transfer clock signal
USB power pins	VCC_USB	Input	Power supply pin. When the USB is not to be used, connect it to the VCC pin.
	VSS_USB	Input	Ground pin. When the USB is not to be used, connect it to the VSS pin.
USB 2.0 host/function module	USB0_DP, USB1_DP	I/O	Inputs or outputs USB transceiver D+ data.
	USB0_DM, USB1_DM	I/O	Inputs or outputs USB transceiver D- data.
	USB0_VBUS, USB1_VBUS	Input	Input pins for detection of connection and disconnection of the USB cable.
	USB0_EXICEN	Output	Output pin for control the low power of the OTG chip.
	USB0_VBUSEN	Output	Supply enable pin of VBUS (5 V) for the OTG chip.
	USB0_OVRCURA, USB0_OVRCURB,	Input	Input pin for detection of external over current.
	USB0_ID	Input	ID input pin of mini-AB connector at the OTG operation.
	USB0_DPUPE, USB1_DPUPE	Output	Pull-up control pins of the D+ signal at the function operation.
	USB0_DPRPD	Output	Pull-down control pins of the D+ signal at the host operation.
	USB0_DRPD	Output	Pull-down control pins of the D- signal at the host operation.
CAN module	CRX0 to CRX2	Input	Input pin.
	CTX0 to CTX2	Output	Output pin.
Serial peripheral interface	RSPCKA, RSPCKB, RSPCKC	I/O	Clock input/output pin.
	MOSIA, MOSIB, MOSIC	I/O	Inputs or outputs data output from the master.
	MISOA, MISOB, MISOC	I/O	Inputs or outputs data output from the slave.
	SSLA0, SSLB0, SSLC0	I/O	Input or output pins slave selection
	SSLA1 to SSLA3, SSLB1 to SSLB3, SSLC1 to SSLC3	Output	Output pins slave selection
IEBus controller	IERXD	Input	Input pin for data reception.
	IETXD	Output	Output pin for data transmission.
Realtime clock	RTCOUT	Output	Output pin for 1-Hz clock.
	RTCIC0 to RTCIC2	Input	Time capture event input pin
12-bit A/D converter	AN000 to AN020	Input	Input pins for the analog signals to be processed by the A/D converter.
	ADTRG0#	Input	Input pins for the external trigger signals that start the A/D conversion.
10-bit A/D converter	AN0 to AN7	Input	Input pins for the analog signals to be processed by the A/D converter.
	ANEX0	Output	Extended analog output pin
	ANEX1	Input	Extended analog input pin
	ADTRG#	Input	Input pins for the external trigger signals that start the A/D conversion.
D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter.

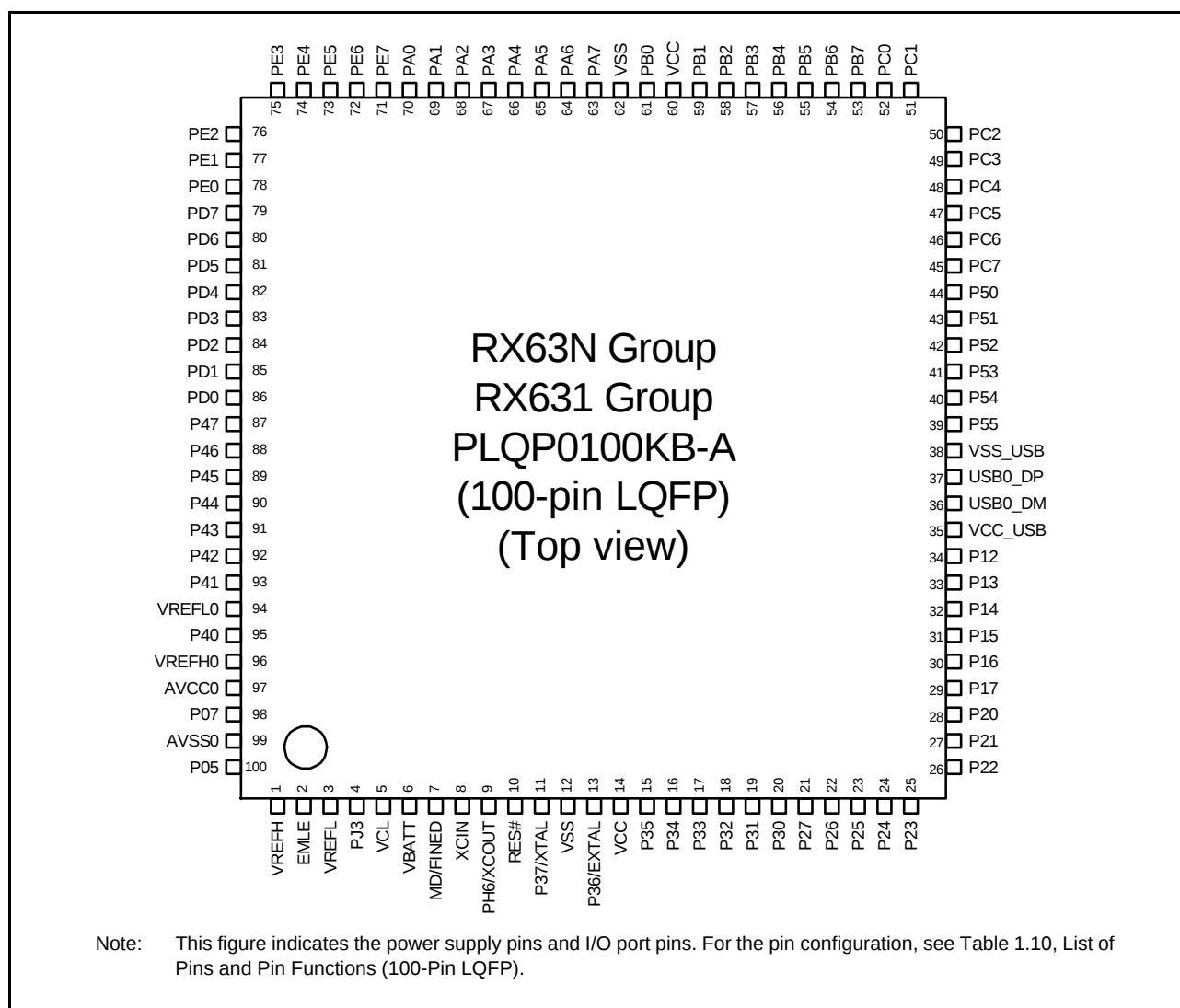
**Figure 1.9 Pin Assignment (100-Pin LQFP)**

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (1/5)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIC, SCID, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD, AD, DA
A1	AVSS0						
A2	AVCC0						
A3	VREFL0						
A4		P42				IRQ10-DS	AN002
A5		P46				IRQ14-DS	AN006
A6	VCC						
A7	VSS						
A8		P94	A20/D20				
A9	VCC						
A10		P97	A23/D23				
A11		PD6	D6[A6/D6]	MTIC5V/POE1#	SSLC2	IRQ6	AN6
A12		P60	CS0#				
A13		P63	CS3#/CAS#				
A14		PE1	D9[A9/D9]	MTIOC4C/TIOCD9/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12/SSLB2/RSPCKB		ANEX1
A15		PE2	D10[A10/D10]	MTIOC4A/TIOCA9/PO23	RXD12/SMISO12/ SSCL12/RXDX12/SSLB3/ MOSIB	IRQ7-DS	AN0
B1		P05				IRQ13	DA1
B2		P07				IRQ15	ADTRG0#
B3		P40				IRQ8-DS	AN000
B4		P41				IRQ9-DS	AN001
B5		P47				IRQ15-DS	AN007
B6		P91	A17/D17		SCK7		AN015
B7		P92	A18/D18		RXD7/SMISO7/SSCL7		AN016
B8		PD1	D1[A1/D1]	MTIOC4B/TIOCB7/ TCLKG	MOSIC/CTX0	IRQ1	AN009
B9		P96	A22/D22				
B10		PD4	D4[A4/D4]	POE3#	SSLC0	IRQ4	AN012
B11		PG1	D25				
B12	VSS						
B13		P64	CS4#/WE#				
B14		PE0	D8[A8/D8]	TIOCC9	SCK12/SSLB1		ANEX0
B15		PE3	D11[A11/D11]	MTIOC4B/TIOCB9/PO26/ POE8#	ET_ERXD3/CTS12#/ RTS12#/SS12#/MISOB		AN1
C1	VREFL						
C2	VREFH						
C3	VREFH0						
C4		P43				IRQ11-DS	AN003
C5		P45				IRQ13-DS	AN005
C6		P90	A16/D16		TXD7/SMOSI7/SSDA7		AN014
C7		PD0	D0[A0/D0]	TIOCA7		IRQ0	AN008
C8		PD2	D2[A2/D2]	MTIOC4D/TIOCA8	MISOC/CRX0	IRQ2	AN010
C9		PD3	D3[A3/D3]	TIOCB8/TCLKH/POE8#	RSPCKC	IRQ3	AN011
C10		PG0	D24				
C11	VCC						
C12		P62	CS2#/RAS#				
C13		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ TIOCA10/PO28	ET_ERXD2/SSLB0		AN2

Table 1.8 List of Pins and Pin Functions (144-Pin LQFP) (5/5)

Pin No. 144-pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIC, SCID, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
125		PD1	D1[A1/D1]	MTIOC4B/TIOCB7/ TCLKG	MOSIC/CTX0	IRQ1	AN009
126		PD0	D0[A0/D0]	TIOCA7		IRQ0	AN008
127		P93	A19		CTS7#/RTS7#/SS7#		AN017
128		P92	A18		RXD7/SMISO7/SSCL7		AN016
129		P91	A17		SCK7		AN015
130	VSS						
131		P90	A16		TXD7/SMOSI7/SSDA7		AN014
132	VCC						
133		P47				IRQ15-DS	AN007
134		P46				IRQ14-DS	AN006
135		P45				IRQ13-DS	AN005
136		P44				IRQ12-DS	AN004
137		P43				IRQ11-DS	AN003
138		P42				IRQ10-DS	AN002
139		P41				IRQ9-DS	AN001
140	VREFL0						
141		P40				IRQ8-DS	AN000
142	VREFH0						
143	AVCC0						
144		P07				IRQ15	ADTRG0#

Note 1. The BCLK function is multiplexed with the I/O port function for pin P53, so the port function is not available if the external bus is enabled.

Note 2. Enabled only for the ROM capacity: 2 Mbytes/1.5 Mbytes

Table 1.10 List of Pins and Pin Functions (100-Pin LQFP) (1/4)

Pin No. 100-pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCId, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
1	VREFH						
2	EMLE						
3	VREFL						
4		PJ3		MTIOC3C	CTS6#/RTS6#/CTS0#/ RTS0#/SS6#/SS0#		
5	VCL						
6	VBATT						
7	MD/FINED						
8	XCIN						
9	XCOUT						
10	RES#						
11	XTAL	P37					
12	VSS						
13	EXTAL	P36					
14	VCC						
15		P35				NMI	
16	TRST#	P34		MTIOC0A/TMC13/ PO12/POE2#	SCK6/SCK0/ USB0_DPRPD	IRQ4	
17		P33		MTIOC0D/TIOC0D/ TMR13/PO11/POE3#	RXD6/RXD0/SMISO6/ SMISO0/SSCL6/ SSCL0/CRX0*1	IRQ3-DS	
18		P32		MTIOC0C/TIOC0C/ TMO3/PO10/RTICOUT/ RTICIC2	TXD6/TXD0/SMOSI6/ SMOSI0/SSDA6/ SSDA0/CTX0*1/ USB0_VBUSEN	IRQ2-DS	
19	TMS	P31		MTIOC4D/TMC12/PO9/ RTICIC1	CTS1#/RTS1#/SS1#/ SSLB0/USB0_DPUPE	IRQ1-DS	
20	TDI	P30		MTIOC4B/TMR13/PO8/ RTICIC0/POE8#	RXD1/SMISO1/SSCL1/ MISOB/USB0_DRPD	IRQ0-DS	
21	TCK/FINEC	P27	CS7#	MTIOC2B/TMC13/PO7	SCK1/RSPCKB		
22	TDO	P26	CS6#	MTIOC2A/TMO1/PO6	TXD1/CTS3#/RTS3#/ SMOSI1/SS3#/SSDA1/ MOSIB		
23		P25	CS5#/EDACK1	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/SSCL3/ USB0_DPRPD		ADTRG0#
24		P24	CS4#/EDREQ1	MTIOC4A/MTCLKA/ TIOCB4/TMR11/PO4	SCK3/USB0_VBUSEN		
25		P23	EDACK0	MTIOC3D/MTCLKD/ TIOC03/PO3	TXD3/CTS0#/RTS0#/ SMOSI3/SS0#/SSDA3/ USB0_DPUPE		
26		P22	EDREQ0	MTIOC3B/MTCLKC/ TIOC03/TMO0/PO2	SCK0/USB0_DRPD		
27		P21		MTIOC1B/TIOCA3/ TMC10/PO1	RXD0/SMISO0/SSCL0/ USB0_EXICEN	IRQ9	
28		P20		MTIOC1A/TIOCB3/ TMR10/PO0	TXD0/SMOSI0/SSDA0/ USB0_ID	IRQ8	
29		P17		MTIOC3A/MTIOC3B/ TIOCB0/TCLKD/TMO1/ PO15/POE8#	SCK1/TXD3/SMOSI3/ SSDA3/MISOA/SDA2- DS/IETXD	IRQ7	ADTRG#
30		P16		MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/TMO2/ PO14/RTICOUT	TXD1/RXD3/SMOSI1/ SMISO3/SSDA1/ SSCL3/MOSIA/SCL2- DS/IERXD/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB	IRQ6	ADTRG0#

Table 1.13 List of Pins and Pin Functions (48-Pin LQFP) (2/2)

Pin Number 48-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU2a, TPUa, TMR, PPG, POE2a)	Communications (SC1c, SC1d, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12ADa, DAa
29		PB0/ PC0	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA	IRQ12	
30	VSS					
31		PA6	MTIC5V/MTCLKB/TIOCA2/ TMC13/PO22/POE2#	CTS5#/RTS5#/SS5#/ MOSIA		
32		PA4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0	IRQ5-DS	
33		PA3	MTIOC0D/MTCLKD/ TIOC0D/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
34		PA1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2	IRQ11	
35		PE4	MTIOC4D/MTIOC1A/ PO28	SSLB0		AN012
36		PE3	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/SS12#/ MISOB		AN011
37		PE2	MTIOC4A/PO23	RXD12/SMISO12/SSCL12/ RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN010
38		PE1	MTIOC4C/PO18	TXD12/SMISO12/SSDA12/ TXDX12/SIOX12/SSLB2/ RSPCKB		AN009
39	VREFL					
40		P46			IRQ14-DS	AN006
41	VREFH					
42		P42			IRQ10-DS	AN002
43		P41			IRQ9-DS	AN001
44	VREFL0					
45		P40			IRQ8-DS	AN000
46	VREFH0					
47	AVCC0					
48	AVSS0					

Table 4.1 List of I/O Registers (Address Order) (7/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 7096h	ICU	Interrupt request register 150	IR150	8	8	2	ICLK	ICUb
0008 7097h	ICU	Interrupt request register 151	IR151	8	8	2	ICLK	
0008 7098h	ICU	Interrupt request register 152	IR152	8	8	2	ICLK	
0008 7099h	ICU	Interrupt request register 153	IR153	8	8	2	ICLK	
0008 709Ah	ICU	Interrupt request register 154	IR154	8	8	2	ICLK	
0008 709Bh	ICU	Interrupt request register 155	IR155	8	8	2	ICLK	
0008 709Ch	ICU	Interrupt request register 156	IR156	8	8	2	ICLK	
0008 709Dh	ICU	Interrupt request register 157	IR157	8	8	2	ICLK	
0008 709Eh	ICU	Interrupt request register 158	IR158	8	8	2	ICLK	
0008 709Fh	ICU	Interrupt request register 159	IR159	8	8	2	ICLK	
0008 70A0h	ICU	Interrupt request register 160	IR160	8	8	2	ICLK	
0008 70A1h	ICU	Interrupt request register 161	IR161	8	8	2	ICLK	
0008 70A2h	ICU	Interrupt request register 162	IR162	8	8	2	ICLK	
0008 70A3h	ICU	Interrupt request register 163	IR163	8	8	2	ICLK	
0008 70A4h	ICU	Interrupt request register 164	IR164	8	8	2	ICLK	
0008 70A5h	ICU	Interrupt request register 165	IR165	8	8	2	ICLK	
0008 70A6h	ICU	Interrupt request register 166	IR166	8	8	2	ICLK	
0008 70A7h	ICU	Interrupt request register 167	IR167	8	8	2	ICLK	
0008 70AAh	ICU	Interrupt request register 170	IR170	8	8	2	ICLK	
0008 70ABh	ICU	Interrupt request register 171	IR171	8	8	2	ICLK	
0008 70ACh	ICU	Interrupt request register 172	IR172	8	8	2	ICLK	
0008 70ADh	ICU	Interrupt request register 173	IR173	8	8	2	ICLK	
0008 70AEh	ICU	Interrupt request register 174	IR174	8	8	2	ICLK	
0008 70AFh	ICU	Interrupt request register 175	IR175	8	8	2	ICLK	
0008 70B0h	ICU	Interrupt request register 176	IR176	8	8	2	ICLK	
0008 70B1h	ICU	Interrupt request register 177	IR177	8	8	2	ICLK	
0008 70B2h	ICU	Interrupt request register 178	IR178	8	8	2	ICLK	
0008 70B3h	ICU	Interrupt request register 179	IR179	8	8	2	ICLK	
0008 70B4h	ICU	Interrupt request register 180	IR180	8	8	2	ICLK	
0008 70B5h	ICU	Interrupt request register 181	IR181	8	8	2	ICLK	
0008 70B6h	ICU	Interrupt request register 182	IR182	8	8	2	ICLK	
0008 70B7h	ICU	Interrupt request register 183	IR183	8	8	2	ICLK	
0008 70B8h	ICU	Interrupt request register 184	IR184	8	8	2	ICLK	
0008 70B9h	ICU	Interrupt request register 185	IR185	8	8	2	ICLK	
0008 70BAh	ICU	Interrupt request register 186	IR186	8	8	2	ICLK	
0008 70BBh	ICU	Interrupt request register 187	IR187	8	8	2	ICLK	
0008 70BCh	ICU	Interrupt request register 188	IR188	8	8	2	ICLK	
0008 70BDh	ICU	Interrupt request register 189	IR189	8	8	2	ICLK	
0008 70BEh	ICU	Interrupt request register 190	IR190	8	8	2	ICLK	
0008 70BFh	ICU	Interrupt request register 191	IR191	8	8	2	ICLK	
0008 70C0h	ICU	Interrupt request register 192	IR192	8	8	2	ICLK	
0008 70C1h	ICU	Interrupt request register 193	IR193	8	8	2	ICLK	
0008 70C2h	ICU	Interrupt request register 194	IR194	8	8	2	ICLK	
0008 70C3h	ICU	Interrupt request register 195	IR195	8	8	2	ICLK	
0008 70C4h	ICU	Interrupt request register 196	IR196	8	8	2	ICLK	
0008 70C5h	ICU	Interrupt request register 197	IR197	8	8	2	ICLK	
0008 70C6h	ICU	Interrupt request register 198	IR198	8	8	2	ICLK	
0008 70C7h	ICU	Interrupt request register 199	IR199	8	8	2	ICLK	
0008 70C8h	ICU	Interrupt request register 200	IR200	8	8	2	ICLK	
0008 70C9h	ICU	Interrupt request register 201	IR201	8	8	2	ICLK	
0008 70CAh	ICU	Interrupt request register 202	IR202	8	8	2	ICLK	

Table 4.1 List of I/O Registers (Address Order) (17/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 81A8h	TPU8	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 81AAh	TPU8	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 81B0h	TPU9	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81B1h	TPU9	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 81B2h	TPU9	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK	
0008 81B3h	TPU9	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK	
0008 81B4h	TPU9	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 81B5h	TPU9	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 81B6h	TPU9	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 81B8h	TPU9	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 81BAh	TPU9	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 81BCh	TPU9	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK	
0008 81BEh	TPU9	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK	
0008 81C0h	TPU10	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C1h	TPU10	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C2h	TPU10	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C4h	TPU10	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 81C5h	TPU10	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C6h	TPU10	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 81C8h	TPU10	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 81CAh	TPU10	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 81D0h	TPU11	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D1h	TPU11	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D2h	TPU11	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D4h	TPU11	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 81D5h	TPU11	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D6h	TPU11	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 81D8h	TPU11	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 81DAh	TPU11	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 81E6h	PPG0	PPG output control register	PCR	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81E7h	PPG0	PPG output mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 81E8h	PPG0	Next data enable register H	NDERH	8	8	2, 3 PCLKB	2 ICLK	
0008 81E9h	PPG0	Next data enable register L	NDERL	8	8	2, 3 PCLKB	2 ICLK	
0008 81EAh	PPG0	Output data register H	PODRH	8	8	2, 3 PCLKB	2 ICLK	
0008 81EBh	PPG0	Output data register L	PODRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81ECh ^{*1}	PPG0	Next data register H	NDRH	8	8	2, 3 PCLKB	2 ICLK	
0008 81EDh ^{*2}	PPG0	Next data register L	NDRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81EEh ^{*1}	PPG0	Next data register H	NDRH2	8	8	2, 3 PCLKB	2 ICLK	
0008 81EFh ^{*2}	PPG0	Next data register L	NDRL2	8	8	2, 3 PCLKB	2 ICLK	
0008 81F0h	PPG1	PPG trigger select register	PTRSLR	8	8	2, 3 PCLKB	2 ICLK	
0008 81F6h	PPG1	PPG output control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81F7h	PPG1	PPG output mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 81F8h	PPG1	Next data enable register H	NDERH	8	8	2, 3 PCLKB	2 ICLK	
0008 81F9h	PPG1	Next data enable register L	NDERL	8	8	2, 3 PCLKB	2 ICLK	
0008 81FAh	PPG1	Output data register H	PODRH	8	8	2, 3 PCLKB	2 ICLK	
0008 81FBh	PPG1	Output data register L	PODRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81FCh ^{*3}	PPG1	Next data register H	NDRH	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81FDh ^{*4}	PPG1	Next data register L	NDRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81FEh ^{*3}	PPG1	Next data register H	NDRH2	8	8	2, 3 PCLKB	2 ICLK	
0008 81FFh ^{*4}	PPG1	Next data register L	NDRL2	8	8	2, 3 PCLKB	2 ICLK	

Table 5.4 DC Characteristics (3) (for D and G Versions (-40 ≤ Ta ≤ +85°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, T_a = T_{opr}

Item				Symbol	Min.	Typ.	Max.	Unit	Test Conditions		
Supply current*1	High-speed operating mode	Max.*2		I _{CC} *3	—	—	100	mA	ICLK = 100 MHz PCLKA = 100MHz PCLKB = 50 MHz FCLK = 50 MHz BCLK = 100MHz		
		Normal*4	Peripheral function: clock signal supplied*4		—	52	—				
			Peripheral function: clock signal stopped*4		—	40	—				
		Sleep mode			—	25	65				
		All-module-clock-stop mode (reference value)			—	20	38				
		Increased by BGO operation*5			—	15	—				
	Low-speed operating mode 1*6				—	4	—			ICLK = 1 MHz	
	Low-speed operating mode 2				—	1	—				ICLK = 32.768 kHz
	Software standby mode				—	0.2	6				
	Deep software standby mode	Power supplied to RAM and USB resume detecting unit	Power not supplied to RAM and USB resume detecting unit		Power-on reset circuit and low-power consumption function disabled	—	22	200	μA		
					Power-on reset circuit and low-power	—	21	60			
						—	6.2	28			
		Increase when the RTC is operating	When a crystal oscillator for low clock loads is in use		—	1.0	—				
			When a crystal oscillator for standard clock loads is in use		—	3.0	—				
		RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)	When a crystal oscillator for low clock loads is in use		—	0.9	—	V _{BATT} = 2.0 V, VCC = 0V			
					—	1.6	—	V _{BATT} = 3.3 V, VCC = 0V			
			When a crystal oscillator for standard clock loads is in use		—	1.7	—	V _{BATT} = 2.0 V (for products with 100 pins or more), VBATT = 2.3 V (for the 64-pin product), VCC = 0V			
					—	3.3	—	V _{BATT} = 3.3 V, VCC = 0V			
Analog power supply current*7	During 12-bit A/D conversion (including temperature sensor)			I _{AVCC0}	—	2.3	3.2	mA			
	During 10-bit A/D conversion			I _{VREFH} *9	—	1.0	1.65				
	During D/A conversion (per unit)				—	0.7	1.0				
	Waiting for A/D, D/A conversion (all units)*10			—	—	25	35		μA		
	A/D, D/A converter in standby mode (all units)*10				—	0.1	4.0		μA		
Reference power supply current	During 12-bit A/D conversion			I _{VREFH0}	—	0.6	0.7	mA			
	Waiting for 12-bit A/D conversion (per unit)				—	0.5	0.6				
	12-bit A/D converter in standby mode (per unit)				—	0.1	2.0		μA		

5.3.5 Bus Timing

Table 5.16 Bus Timing (packages with 177 to 144 pins)

Conditions: $V_{CC} = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V,
 $ICLK = 8$ to 100 MHz, $BCLK$ pin = 8 to 50 MHz, $SDCLK$ pin = 8 to 50 MHz, $T_a = T_{opr}$
 Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $I_{OH} = -1.0$ mA, $I_{OL} = 1.0$ mA, $C = 30$ pF
 High drive output is selected by the drive capacity control register.

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	15	ns	Figure 5.17 to Figure 5.22
Byte control delay time	t_{BCD}	—	15	ns	
CS# delay time	t_{CSD}	—	15	ns	
ALE delay time	t_{ALED}	—	20	ns	
RD# delay time	t_{RSD}	—	15	ns	
Read data setup time	t_{RDS}	15	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	15	ns	
Write data delay time	t_{WDD}	—	15	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	15	—	ns	Figure 5.23
WAIT# hold time	t_{WTH}	0	—	ns	
Address delay time 2 (SDRAM)	t_{AD2}	1	15	ns	Figure 5.24 to Figure 5.30
CS# delay time 2 (SDRAM)	t_{CSD2}	1	15	ns	
DQM delay time (SDRAM)	t_{DQMD}	1	15	ns	
CKE delay time (SDRAM)	t_{CKED}	1	15	ns	
Read data setup time 2 (SDRAM)	t_{RDS2}	12	—	ns	
Read data hold time 2 (SDRAM)	t_{RDH2}	0	—	ns	
Write data delay time 2 (SDRAM)	t_{WDD2}	—	15	ns	
Write data hold time 2 (SDRAM)	t_{WDH2}	1	—	ns	
WE# delay time (SDRAM)	t_{WED}	1	15	ns	
RAS# delay time (SDRAM)	t_{RASD}	1	15	ns	
CAS# delay time (SDRAM)	t_{CASD}	1	15	ns	

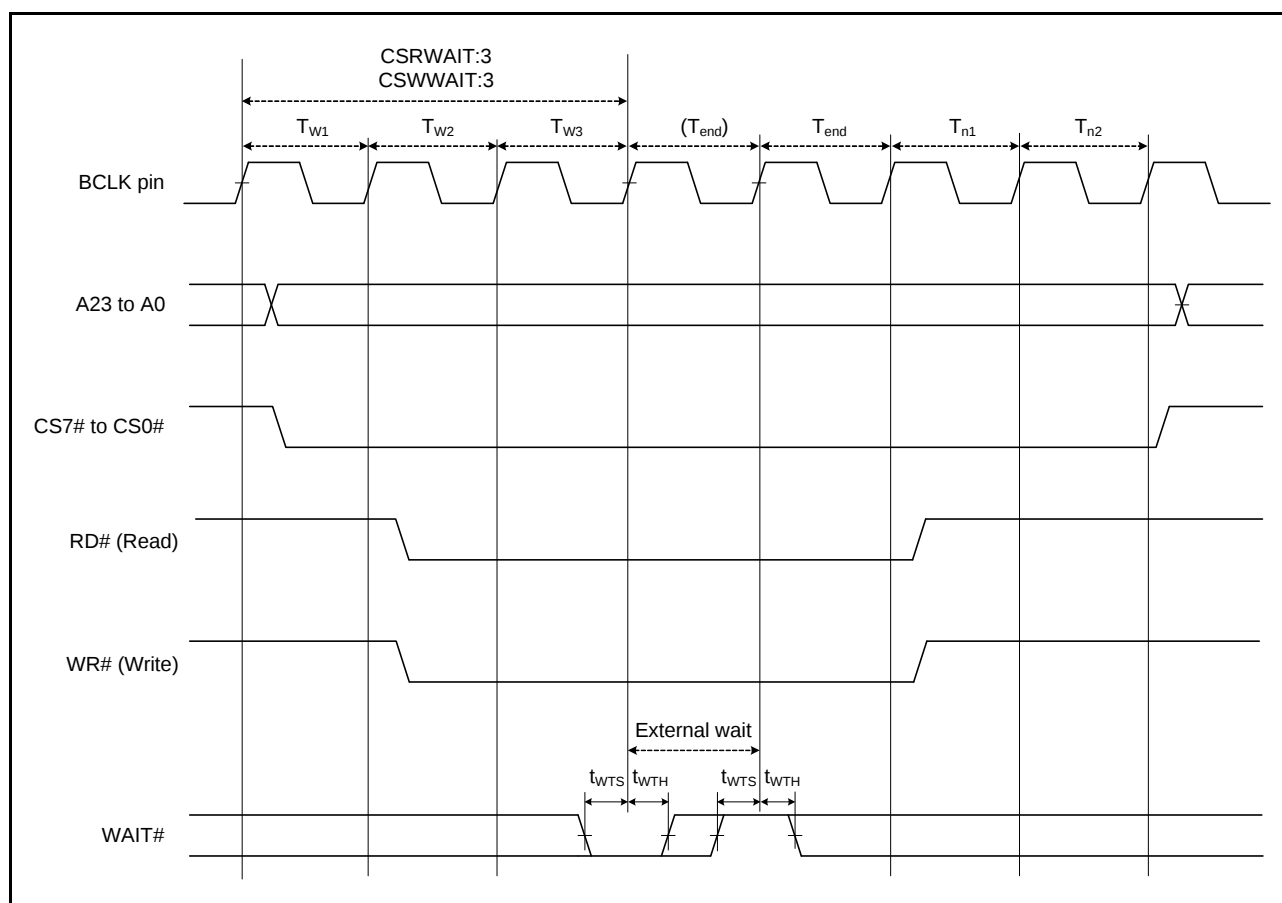
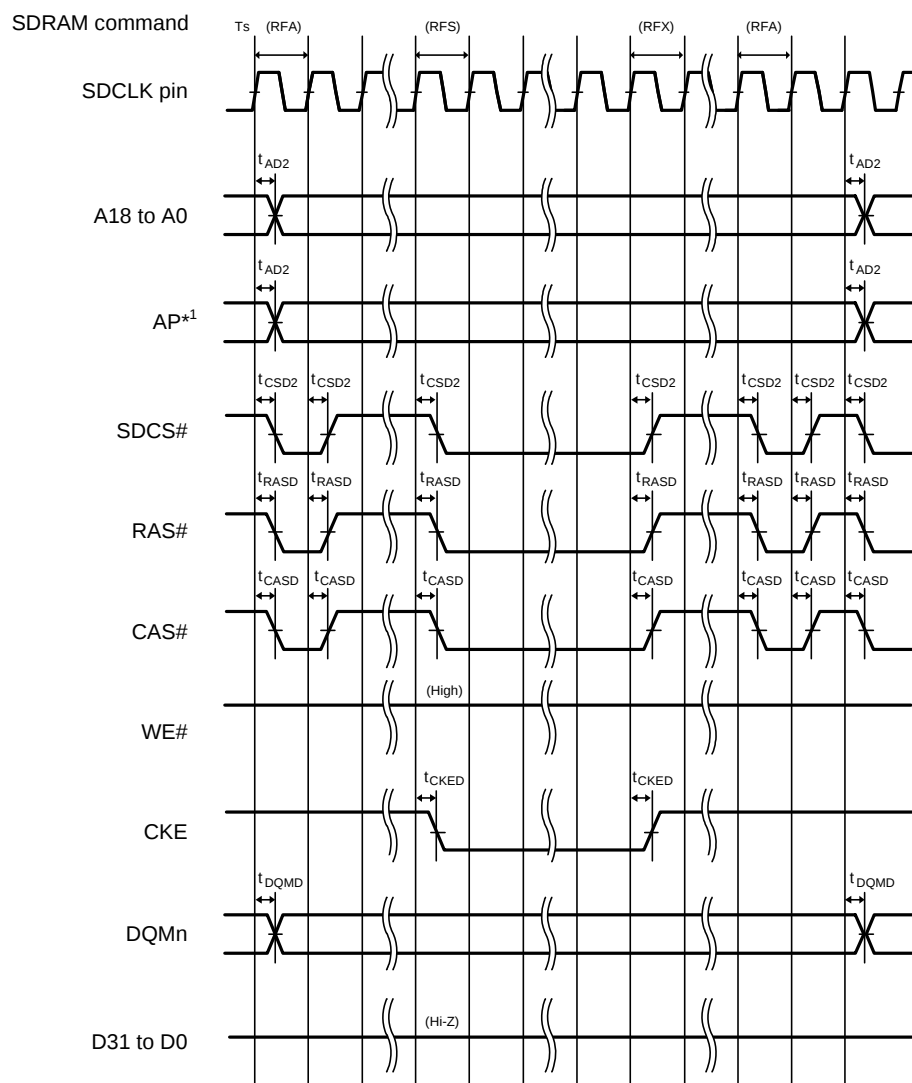


Figure 5.23 External Bus Timing/External Wait Control



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.30 SDRAM Space Self-Refresh Bus Timing

Table 5.25 Timing of On-Chip Peripheral Modules (7)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0

VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V

ICLK = 12.5 to 100 MHz, T_a = T_{opr}

High drive output is selected by the drive capacity control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions
ETHERC(RMII)	REF50CK cycle time	T _{ck}	20	—	ns	Figure 5.48 to Figure 5.51
	REF50CK frequency Typ. 50 MHz	—	—	50 + 100ppm	MHz	
	REF50CK duty	—	35	65	%	
	REF50CK rise/fall time	T _{ckr/ckf}	0.5	3.5	ns	
	RMII_XXXX*1 output delay time	T _{co}	2.5	15.0	ns	
	RMII_XXXX*2 setup time	T _{su}	3	—	ns	
	RMII_XXXX*2 hold time	T _{hd}	1	—	ns	
	RMII_XXXX*1, *2 rise/fall time	Tr/Tf	0.5	6	ns	
	ET_WOL output delay time	t _{WOLd}	1	23.5	ns	Figure 5.52
ETHERC(MII)	ET_TX_CLK cycle time	t _{Tcyc}	40	—	ns	—
	ET_TX_EN output delay time	t _{TENd}	1	20	ns	Figure 5.53
	ET_ETXD0 to ET_ETXD3 output delay time	t _{MTDd}	1	20	ns	
	ET_CRs setup time	t _{CRSs}	10	—	ns	
	ET_CRs hold time	t _{CRSh}	10	—	ns	
	ET_COL setup time	t _{COLs}	10	—	ns	Figure 5.54
	ET_COL hold time	t _{COLh}	10	—	ns	
	ET_RX_CLK cycle time	t _{TRcyc}	40	—	ns	—
	ET_RX_DV setup time	t _{RDVs}	10	—	ns	Figure 5.55
	ET_RX_DV hold time	t _{RDVh}	10	—	ns	
	ET_ERXD0 to ET_ERXD3 setup time	t _{MRDs}	10	—	ns	
	ET_ERXD0 to ET_ERXD3 hold time	t _{MRDh}	10	—	ns	
	ET_RX_ER setup time	t _{RERs}	10	—	ns	Figure 5.56
	ET_RX_ER hold time	t _{RESh}	10	—	ns	
	ET_WOL output delay time	t _{WOLd}	1	23.5	ns	Figure 5.57

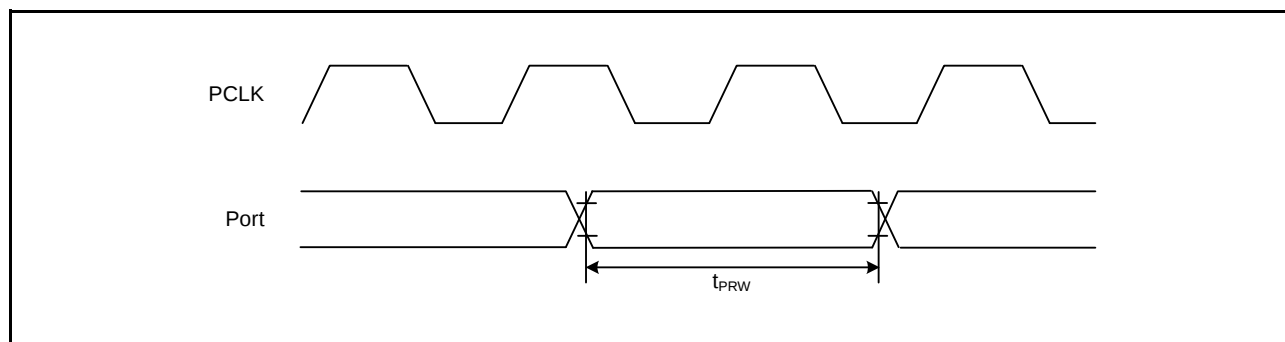
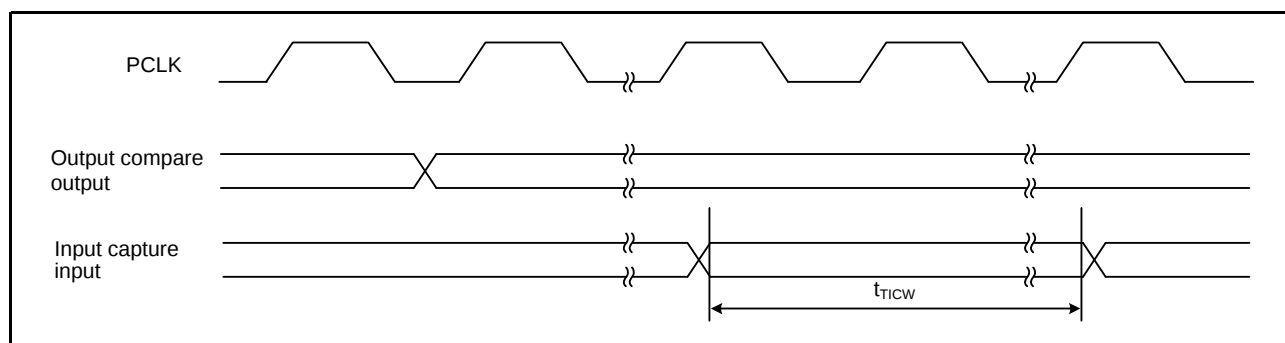
Note 1. RMII_TXD_EN, RMII_TXD1, RMII_TXD0.

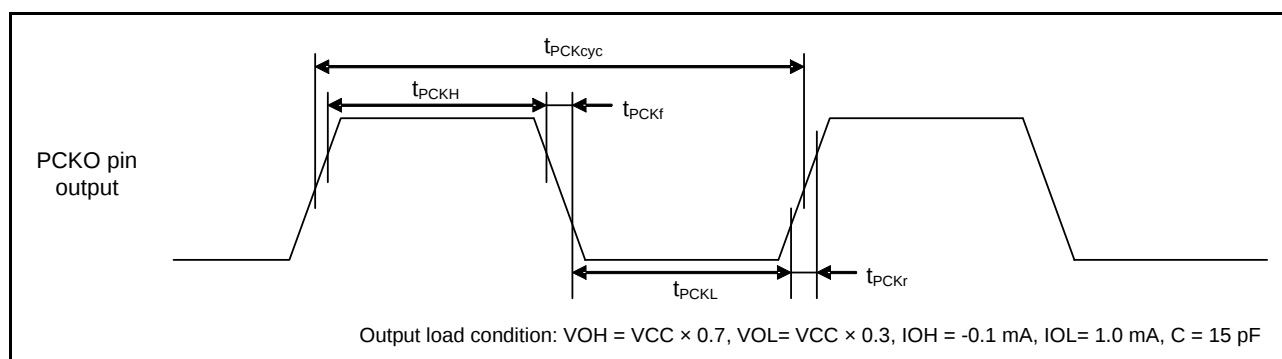
Note 2. RMII_CRs_DV, RMII_RXD1, RMII_RXD0, RMII_RX_ER

Table 5.26 Timing of On-Chip Peripheral Modules (8)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6V, VREFH0 = 2.7V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0V, PIXCLK = 27MHz, T_a = T_{opr}

	Item	Symbol	min	typ	max	Unit	Test Conditions
PDC	VSXNC/HSXNC input setup time	t _{SYNCSXNCSETUP}	10	—	—	ns	Figure 5.58
	VSXNC/HSXNC input hold time	t _{SYNCSXNCXNC}	5	—	—	ns	
	PIXD input setup time	t _{DATAPIXDSETUP}	10	—	—	ns	
	PIXD input hold time	t _{DATAPIXD}	5	—	—	ns	
	PIXCLK input cycle time	t _{PIXCLKcyc}	37	—	1000	ns	Figure 5.59
	PIXCLK input pulse width high level	t _{PIXCLKH}	10	—	—	ns	
	PIXCLK input pulse width low level	t _{PIXCLKL}	10	—	—	ns	
	PCKO pin output cycle time	t _{PCKOcyc}	40	—	1000	ns	Figure 5.60
	PCKO pin output high level pulse width	t _{PCKOH}	13	—	—	ns	
	PCKO pin output low level pulse width	t _{PCKOL}	13	—	—	ns	
	PCKO pin output rising time	t _{PCKOr}	—	—	5	ns	
	PCKO pin output falling time	t _{PCKOf}	—	—	5	ns	

**Figure 5.34 I/O Port Input Timing****Figure 5.35 MTU Input/Output Timing**

**Figure 5.60 PDC Output Clock Characteristic**

5.5 A/D Conversion Characteristics

Table 5.28 10-Bit A/D Conversion CharacteristicsConditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0} $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V $PCLK = 8$ to 50 MHz $T_a = T_{opr}$

Item			Min.	Typ.	Max.	Unit	Test Conditions
Resolution			—	—	10	Bit	
Conversion time*1 (Operation at PCLK = 50 MHz)	With 0.1-μF external capacitor	When the capacitor is charged enough*2	3.0 (2.5)*3	—	—	μs	Sampling in 125 states
	Without 0.1-μF external capacitor	Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 3.0 V	1.5 (1.0)*3	—	—		Sampling in 50 states
		Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 2.7 V	3.5 (3.0)*3	—	—		Sampling in 150 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 3.0 V	2.0 (1.5)*3	—	—		Sampling in 75 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 2.7 V	4.0 (3.5)*3	—	—		Sampling in 175 states
Analog input capacitance			—	—	6.0	pF	
Offset error			—	±1.5	±3.0	LSB	
Full-scale error			—	±1.5	±3.0	LSB	
Quantization error			—	±0.5	—	LSB	
Absolute accuracy			—	±1.5	±3.0	LSB	
DNL differential nonlinearity error			—	±0.5	±1.0	LSB	
INL integral nonlinearity error			—	±1.5	±3.0	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The scanning is not supported.

Note 3. The value in parentheses indicates the sampling time.

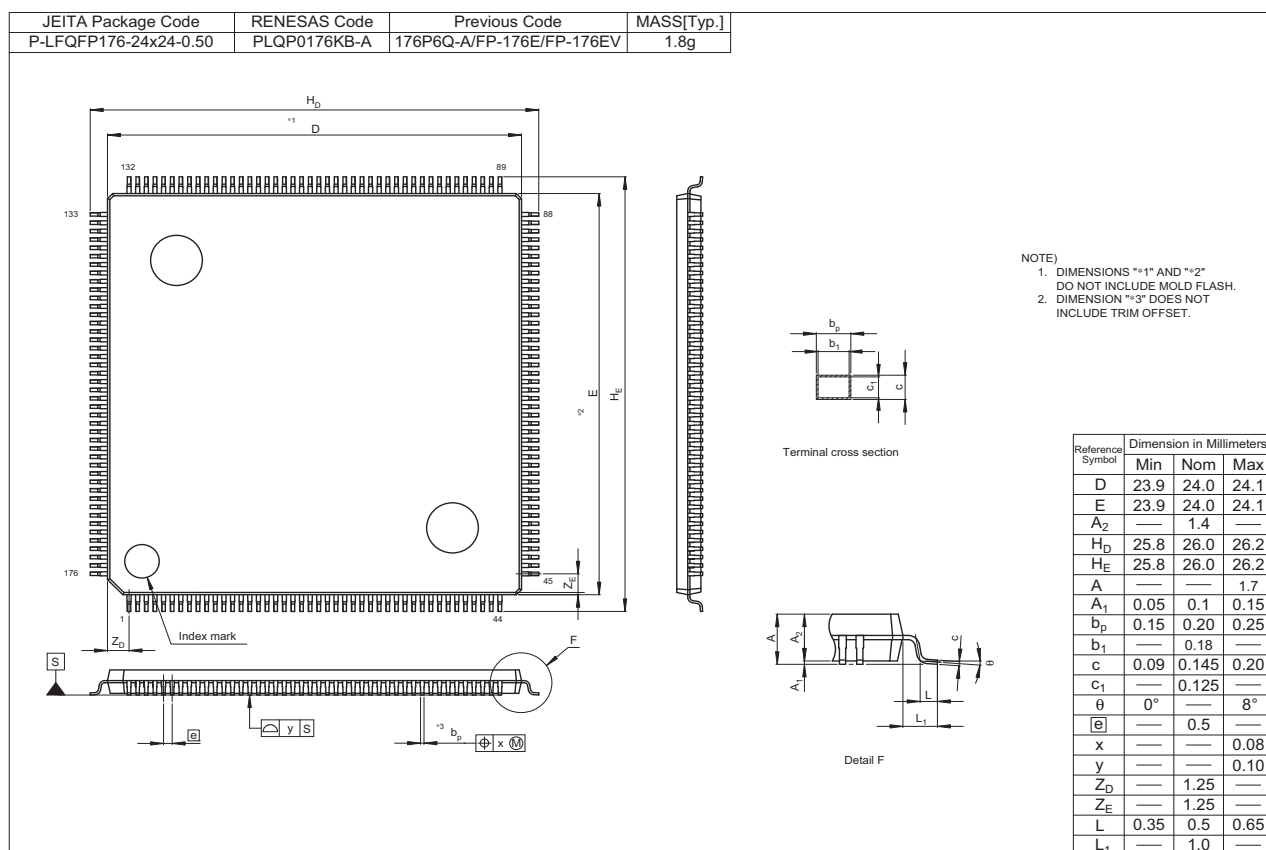


Figure C 176-pin LQFP (PLQP0176KB-A)

Rev.	Date	Description	
		Page	Summary
1.60	Mar 13. 2013	Feature	
		1	Changed
		1. Overview	
		2 to 7	Table 1.1 Outline of Specifications: changed, note added
		8	Table 1.2 Comparison of Functions for Different Packages in the RX63N/RX631 Group, changed
		9 to 15	Table 1.3 List of Products, changed
		16	Figure 1.1 How to Read the Product Part No., changed
		17	Figure 1.2 Block Diagram, changed
		24 to 32	Figure 1.3 to Figure 1.11 Pin Assignment: note, added
		53 to 57	Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA), added
		62 to 64	Table 1.11 List of Pins and Pin Functions (64-Pin LQFP), added
		65, 66	Table 1.12 List of Pins and Pin Functions (48-Pin LQFP), added
		3. Address Space	
		71	Figure 3.1 Memory Map in Each Operating Mode, changed
		4. I/O Registers	
		75 to 120	Table 4.1 List of I/O Registers (Address Order), changed
		5. Electrical Characteristics	
		All	Characteristics and timing conditions in the tables, changed
		124, 125	Table 5.4 DC Characteristics (3), changed
		126	Table 5.5 DC Characteristics (4), changed
		127	5.3 AC Characteristics, changed
		130, 131	Table 5.11, Clock Timing (Except for Sub-Clock Related): Condition and the table, changed, note, added
		132	Table 5.12 Clock Timing (Sub-Clock Related): Condition and the table, changed, note, added
		176	Table 5.33 Battery Backup Function Characteristics: Condition, changed
		Appendix 1. Package Dimensions	
		189	Figure H 64-pin LQFP (PLQP0064KB-A), added
		190	Figure I 48-pin LQFP (PLQP0048KB-A), added
1.70	Oct 08. 2013	Features	
		1	changed
		1. Overview	
		2 to 7	Table 1.1 Outline of Specifications, General I/O ports, Packages, changed, Parallel data capture unit (PDC), added.
		8	Table 1.2 Comparison of Functions for Different Packages in the RX63N/RX631 Group, 64-pin LQFP, changed, 64-pin TFLGA, Parallel data capture unit (PDC), added.
		9 to 16	Table 1.3 List of Products, changed.
		17	Figure 1.1 How to Read the Product Part No., changed
		18	Figure 1.2 Block Diagram, changed
		19 to 24	Table 1.4 Pin Functions, changed, Parallel data capture unit (PDC), added
		32	Figure 1.10 Pin Assignment (64-Pin TFLGA), added
		35 to 40	Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA), changed
		41 to 45	Table 1.6 List of Pin and Pin Functions (176-Pin LQFP), changed
		46 to 50	Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA), changed
		51 to 55	Table 1.8 List of Pins and Pin Functions (144-Pin LQFP), changed
		65 to 66	Table 1.11 List of Pins and Pin Functions (64-Pin TFLGA), added
		3. Address Space	
		76	Figure 3.1 Memory Map in Each Operating Mode, changed
		4. I/O Registers	
		79	(4) Restrictions in Relation to RMPA and String-Manipulation Instructions, added